

Features

- Ideal for indication light on hand held products
- Long life and robust package
- Variety of lens types and color choices available
- ESD protection
- Package: 2000pcs / reel
- Moisture sensitivity level : level 2a
- RoHS compliant



ATTENTION
OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
DISCHARGE
SENSITIVE
DEVICES

Application Note

Static electricity and surge damage the LEDS.

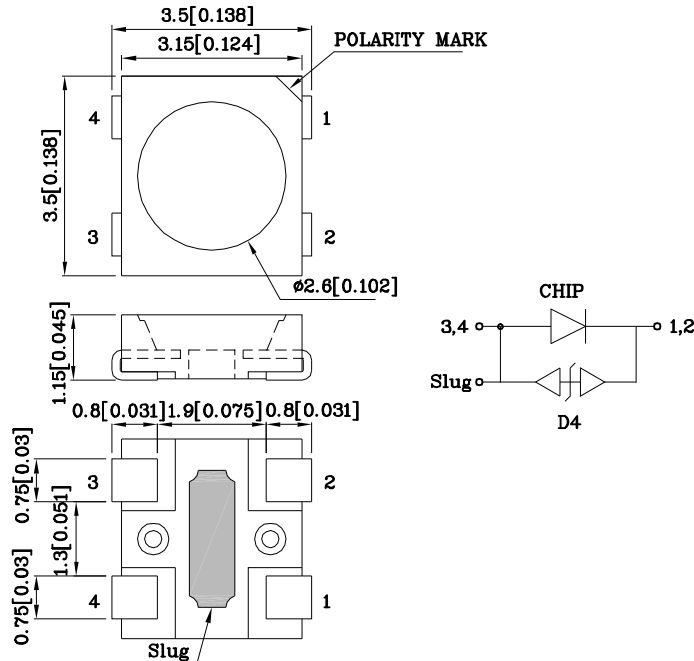
It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDS.

All devices, equipment and machinery must be electrically grounded.

Applications

- Signal and symbol luminaire for orientation.
- Marker lights (e.g. steps, exit ways, etc).
- Decorative and entertainment lighting.
- Commercial and residential lighting.
- Automotive interior lighting.

Package Schematics



Notes:

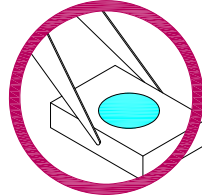
1. All dimensions are in millimeters (inches).
2. Tolerance is $\pm 0.25(0.01)$ unless otherwise noted.
3. Specifications are subject to change without notice.

Handling Precautions

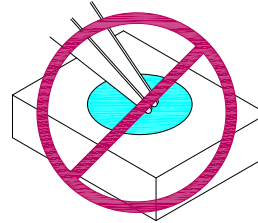
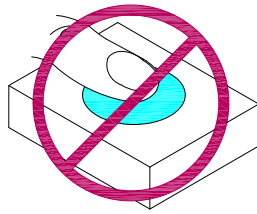
Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force.

As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might lead to damage and premature failure of the LED.

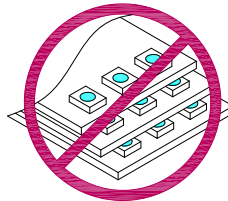
1. Handle the component along the side surfaces by using forceps or appropriate tools.



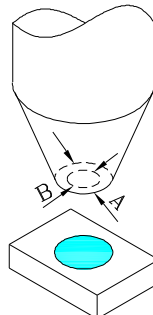
2. Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.



3. Do not stack together assembled PCBs containing exposed LEDs. Impact may scratch the silicone lens or damage the internal circuitry.



- 4.1. The inner diameter of the SMD pickup nozzle should not exceed the size of the LED to prevent air leaks.
- 4.2. A pliable material is suggested for the nozzle tip to avoid scratching or damaging the LED surface during pickup.
- 4.3. The dimensions of the component must be accurately programmed in the pick-and-place machine to insure precise pickup and avoid damage during production.



5. As silicone encapsulation is permeable to gases, some corrosive substances such as H_2S might corrode silver plating of leadframe. Special care should be taken if an LED with silicone encapsulation is to be used near such substances.

Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity CIE127-2007* (IF=150mA) cd		Luminous Flux CIE127-2007* (IF=150mA) lm		Viewing Angle 2 θ 1/2 [1]
				min.	typ.	min.	typ.	
XZDG25X92S-4	Green	InGaN	Water Clear	4.2*	5.99*	14*	19.7*	120°

Notes:

1. θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

2. Luminous intensity / luminous flux: +/-15%.

3. LEDs are binned according to their luminous flux.

* Luminous intensity / luminous flux value is in accordance with CIE127-2007 standards.

Absolute Maximum Ratings at TA=25°C

Parameter	Symbol	Value	Unit
Power Dissipation	P _D	600	mW
Junction Temperature [1]	T _J	110	°C
Operating Temperature	T _{op}	-40 To +85	°C
Storage Temperature	T _{stg}	-40 To +85	°C
DC Forward Current[1]	I _F	150	mA
Peak Forward Current [3]	I _{FM}	300	mA
Reverse Voltage	V _R	5	V
Thermal Resistance [1] (Junction/ambient)	R _{th j-a}	170	°C/W
Thermal Resistance [1] (Junction/solder point)	R _{th j-S}	50	°C/W
Electrostatic Discharge Threshold (HBM)		8000	V

Notes:

1.Results from mounting on PC board FR4(pad size≥70mm²), mounted on pc board-metal core PCB is recommend for lowest thermal Resistance.

2.1/10 Duty Cycle, 0.1ms Pulse Width.

Electrical / Optical Characteristics at TA=25°C

Parameter	Symbol	Value	Unit
Wavelength at peak emission IF=150mA CIE127-2007* [Typ.]	λ peak	515*	nm
Dominant Wavelength IF=150mA CIE127-2007* [Typ.]	λ dom	525*	nm
Spectral Line Half-width IF=150mA [Typ.]	Δλ	30	nm
Forward Voltage IF=150mA [Min.]	V _F	2.9	V
Forward Voltage IF=150mA [Typ.]		3.5	
Forward Voltage IF=150mA [Max.]		4.0	
Allowable Reverse Current [Max.]	I _R	85	mA
Temperature coefficient of λ peak IF=150mA, -10°C≤ T≤100°C [Typ.]	TC λ peak	0.09	nm/°C
Temperature coefficient of λ dom IF=150mA, -10°C≤ T≤100°C [Typ.]	TC λ dom	0.03	nm/°C
Temperature coefficient of V _F IF=150mA, -10°C≤ T≤100°C [Typ.]	TCV	-2.7	mV/°C

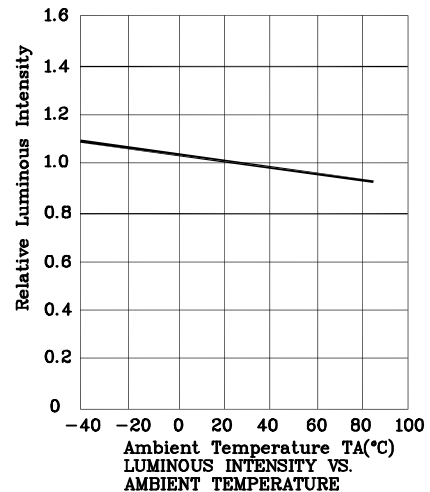
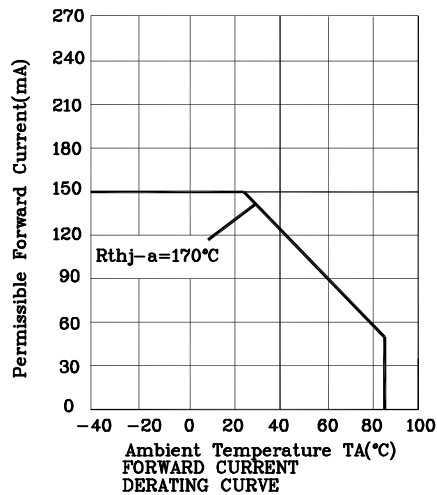
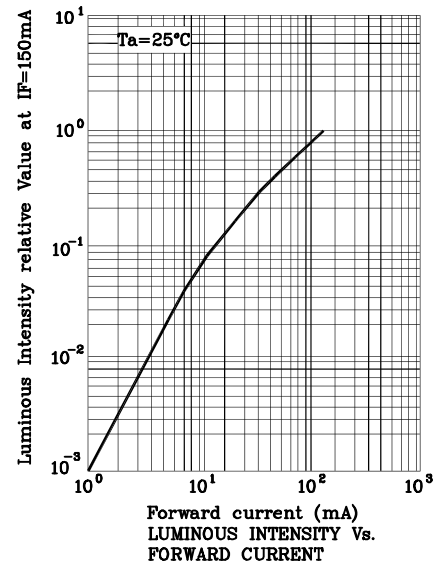
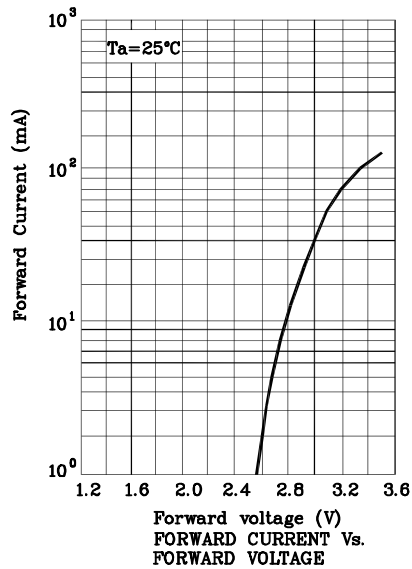
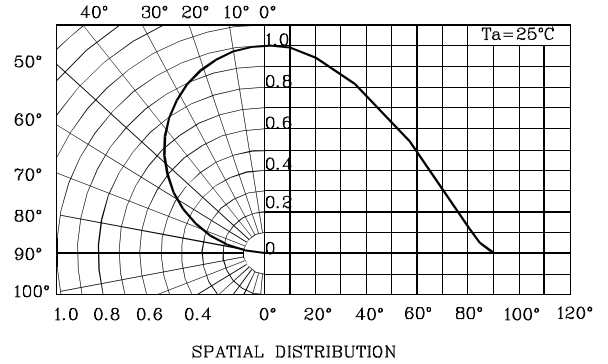
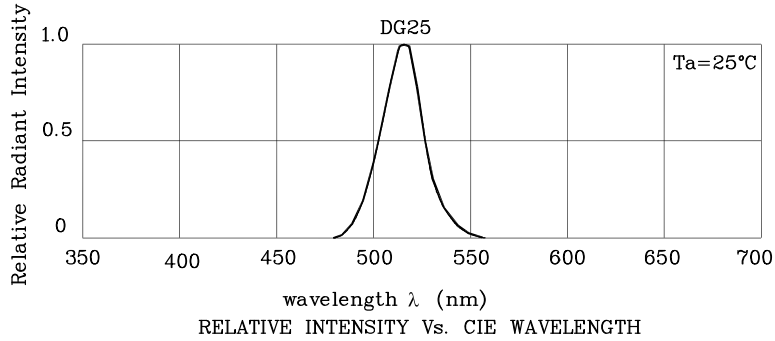
Notes:

1.The dominant Wavelength (λ_d) above is the setup value of the sorting machine. (Tolerance λ_d : ±1nm.)

2. Forward Voltage: +/-0.1V.

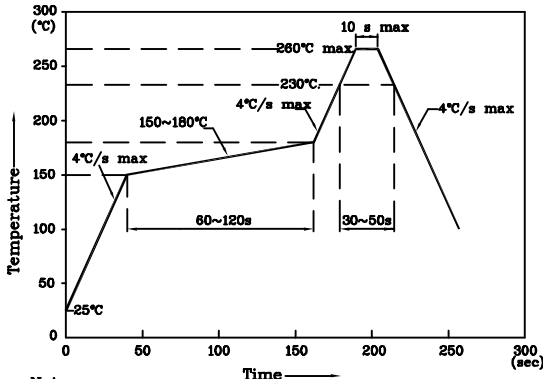
*Wavelength value is in accordance with CIE127-2007 standards.

XZDG25X92S-4



❖ LED is recommended for reflow soldering and soldering profile is shown below.

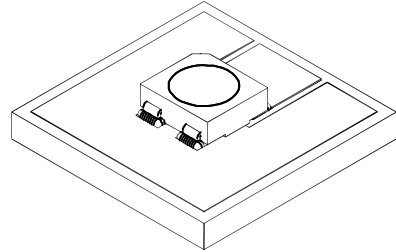
Reflow Soldering Profile for SMD Products (Pb-Free Components)



Notes:

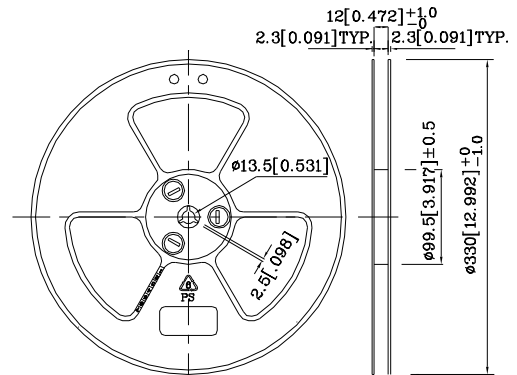
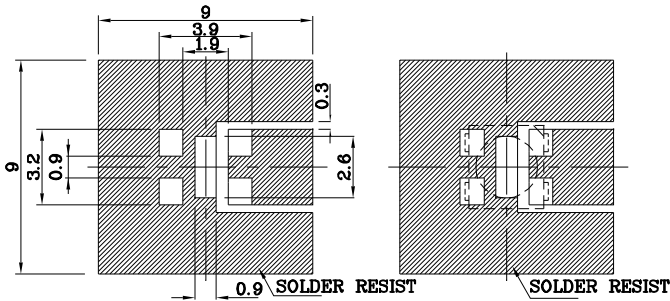
1. Maximum soldering temperature should not exceed 260°C
2. Recommended reflow temperature: 145°C-260°C
3. Do not put stress to the epoxy resin during high temperatures conditions

❖ The device has a single mounting surface. The device must be mounted according to the specifications.

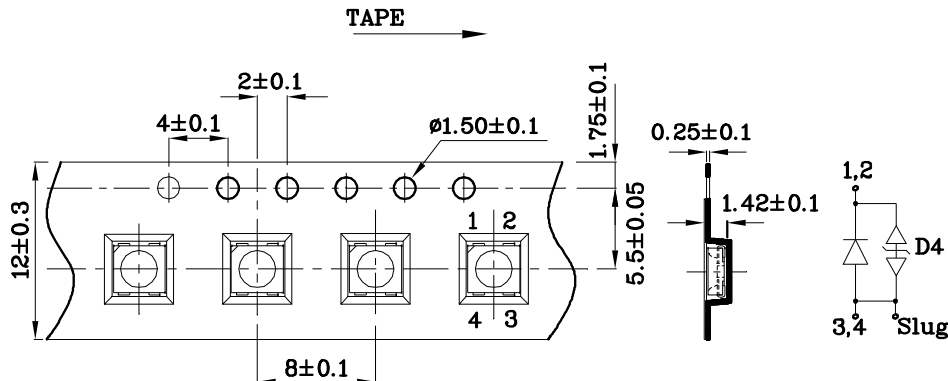


❖ Reel Dimension

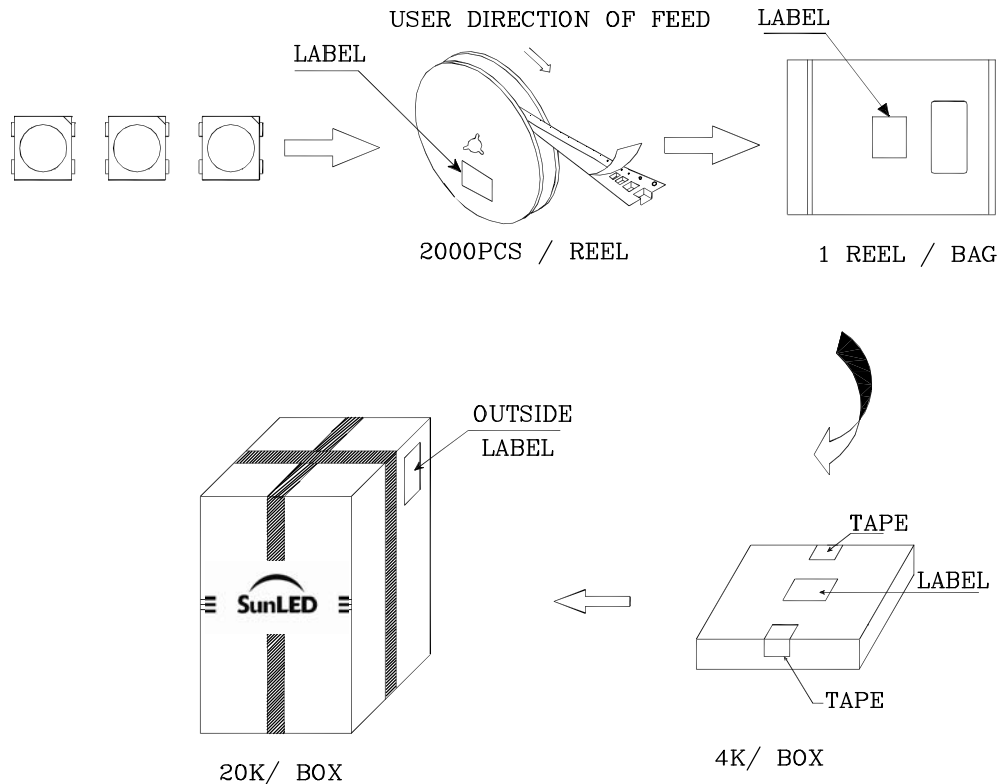
❖ Recommended Soldering Pattern



❖ Tape Specification (Units : mm)



PACKING & LABEL SPECIFICATIONS



P/NO : XZxxx92x		
QTY : 2000 pcs		CODE: XXX
S/N : XX		
LOT NO :		
 XXXXXXXXXXXXXXXXXXXXXXXXXXXX		
RoHS Compliant		

TERMS OF USE

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